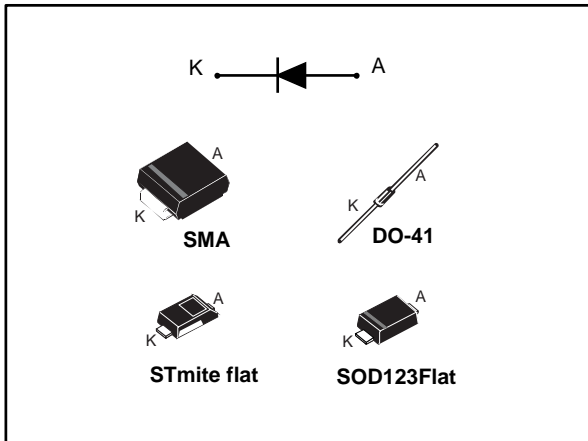


Power Schottky rectifier

Datasheet - production data



Description

Axial and surface mount power Schottky rectifiers suited to switched mode power supplies and high frequency DC to DC converters.

Packaged in SMA, STmite flat, DO-41 and SOD123Flat, this device is especially intended for use in low voltage, high frequency inverters and small battery chargers.

Table 1: Device summary

Symbol	Value
$I_{F(AV)}$	1 A
V_{RRM}	60 V
$V_F(\text{typ.})$	0.50 V
$T_j(\text{max.})$	175 °C

Features

- Negligible switching losses
- Low forward voltage drop
- Surface mount miniature packages
- Avalanche capability specified

1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter		Value	Unit	
V _{RRM}	Repetitive peak reverse voltage		60	V	
I _{F(RMS)}	Forward rms current		SMA/DO-41	10	A
			STmite flat	2	
I _{F(AV)}	Average forward current δ = 0.5, square wave	SMA	T _L = 155 °C	1	A
		DO-41	T _L = 145 °C		
		SOD123Flat	T _L = 160 °C		
		STmite flat	T _C = 160 °C		
I _{FSM}	Surge non repetitive forward current	SMA DO-41 STmite flat	t _p = 10 ms sinusoidal	40	A
		SOD123Flat		50	
		Repetitive peak avalanche power		t _p = 10 μs, T _j = 125 °C	
T _{stg}	Storage temperature range		-65 to +175	°C	
T _j	Operating junction temperature range ⁽¹⁾		-40 to +175	°C	

Notes:

⁽¹⁾(dP_{tot}/dT_j) < (1/R_{th(j-a)}) condition to avoid thermal runaway for a diode on its own heatsink.

Table 3: Thermal parameters

Symbol	Parameter	Max. value	Unit	
R _{th(j-l)}	Junction to lead	SMA	30	°C/W
		DO-41/lead length = 10 mm	45	
		SOD123Flat	20	
R _{th(j-c)}	Junction to case	STmite flat	20	

Table 4: Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = V_{RRM}$	-		50	μA
		$T_j = 100\text{ °C}$		-	1.5	5	mA
		$T_j = 125\text{ °C}$		-	5.6	21	
$V_F^{(1)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 1\text{ A}$	-		0.57	V
		$T_j = 125\text{ °C}$		-	0.50	0.54	
		$T_j = 25\text{ °C}$	$I_F = 2\text{ A}$	-		0.75	
		$T_j = 125\text{ °C}$		-	0.60	0.66	

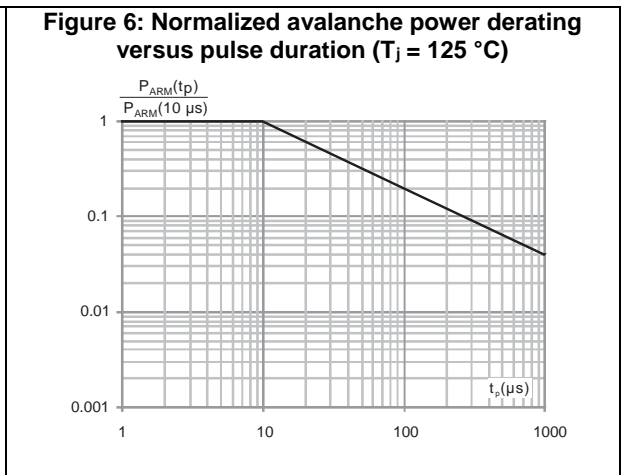
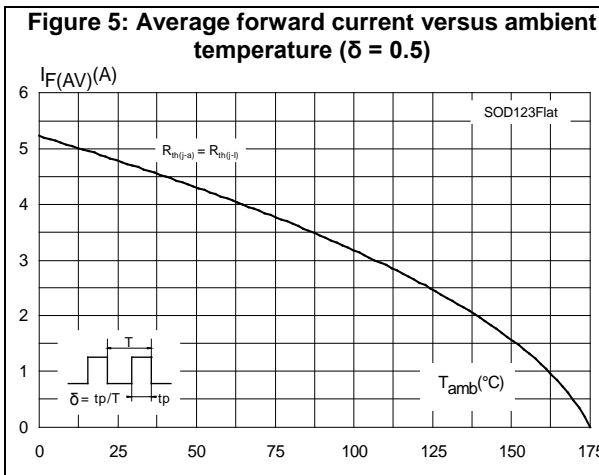
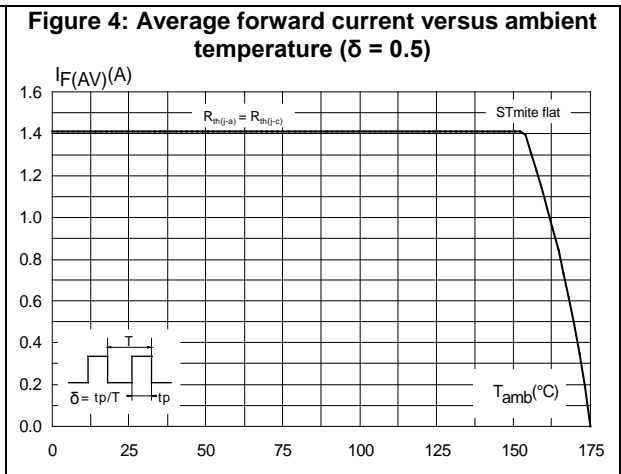
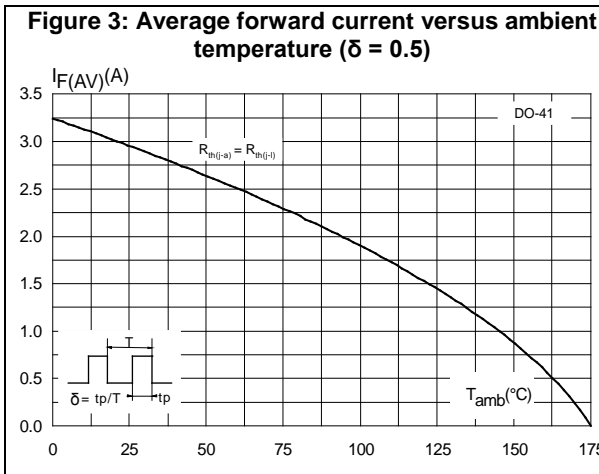
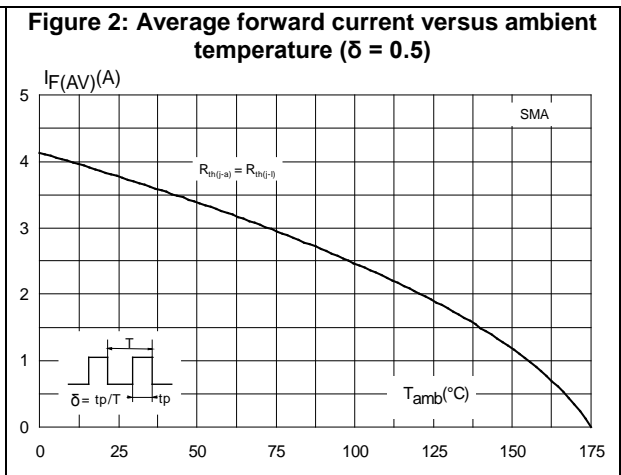
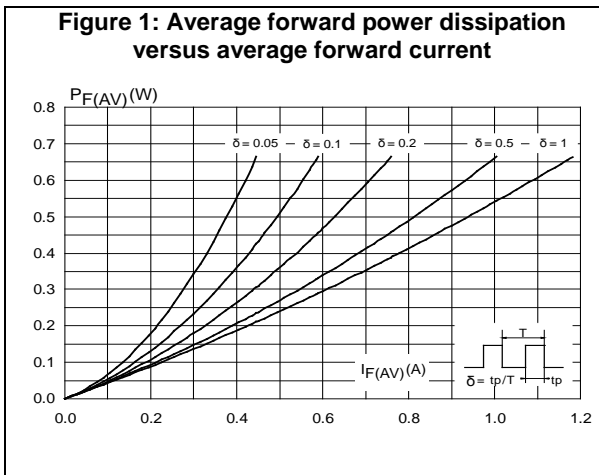
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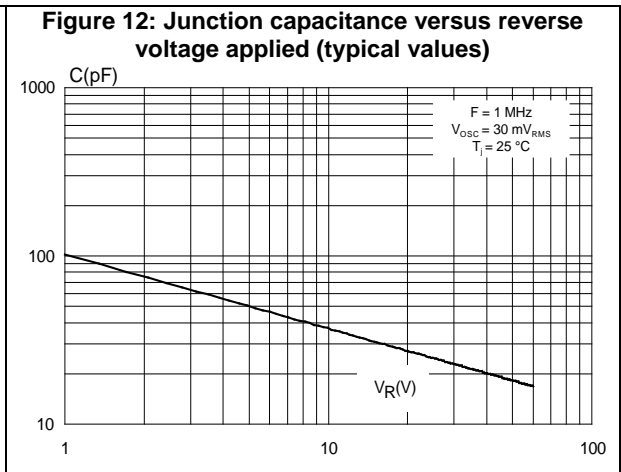
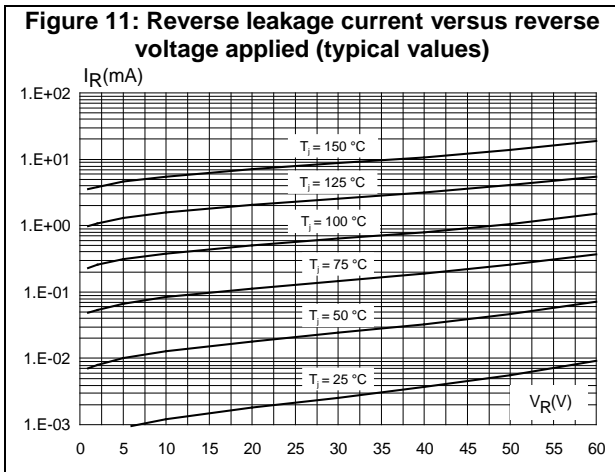
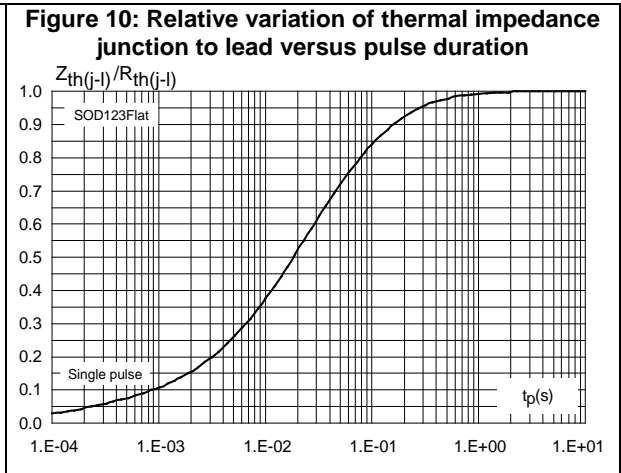
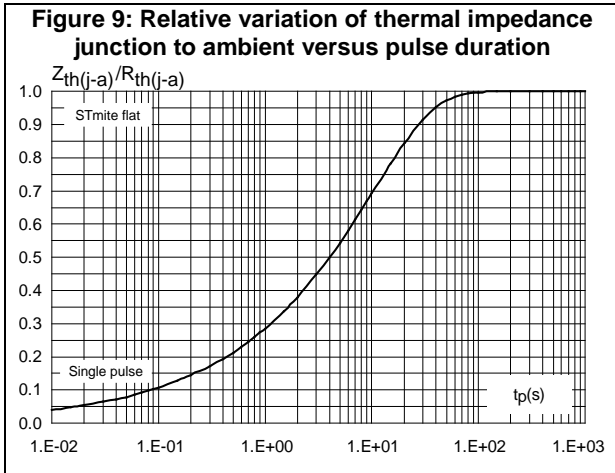
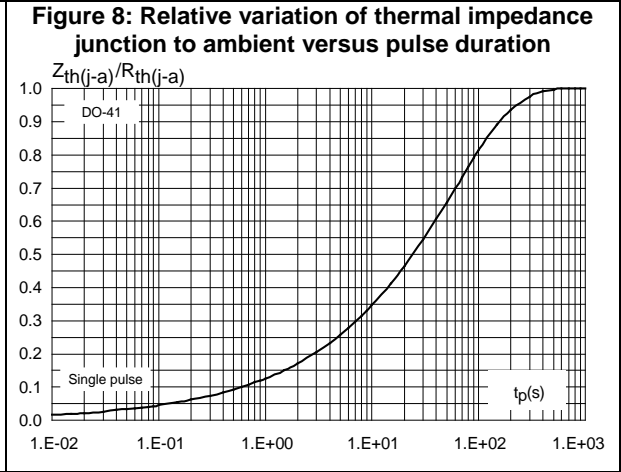
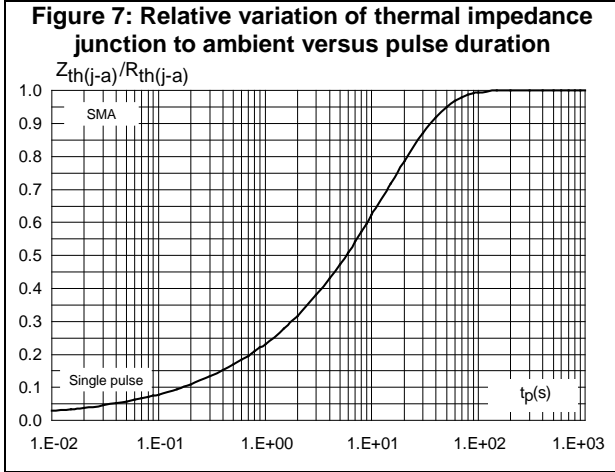
⁽¹⁾Pulse test: $t_p = 380\text{ }\mu\text{s}$, $\delta < 2\%$

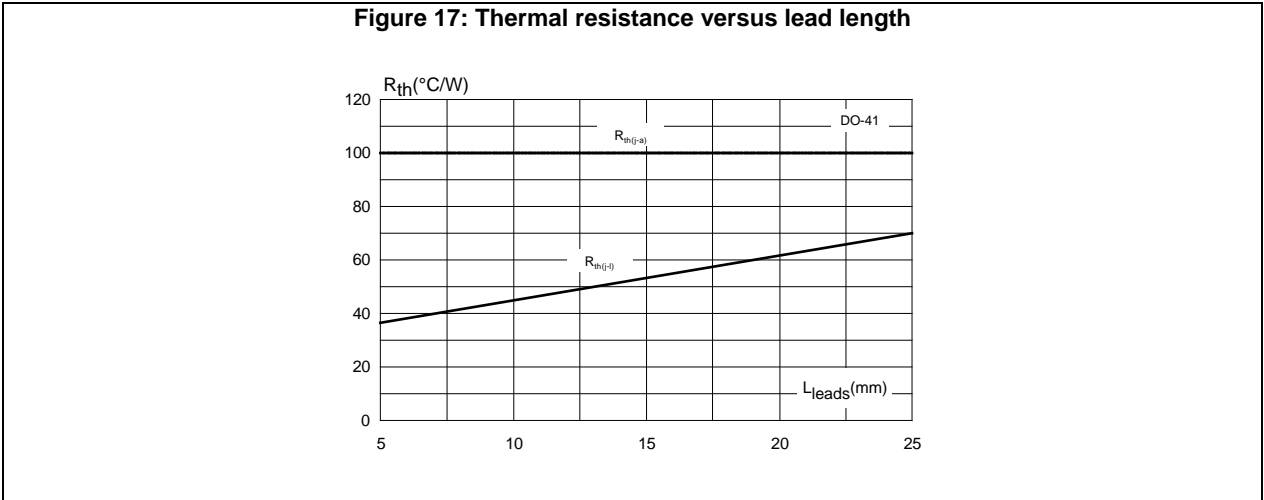
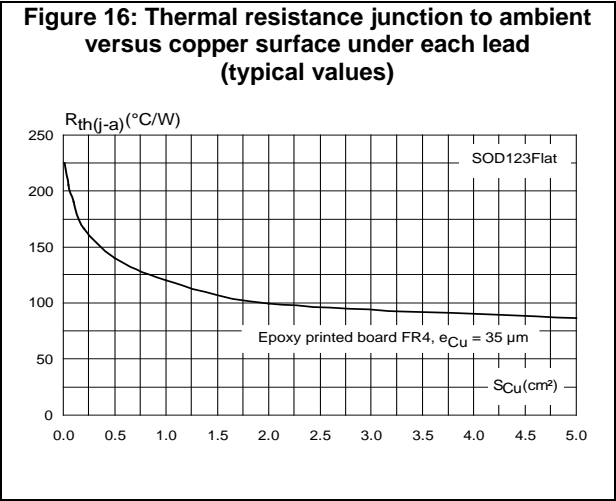
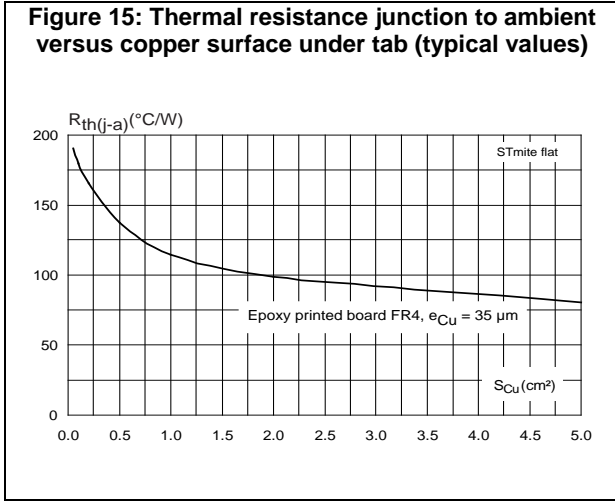
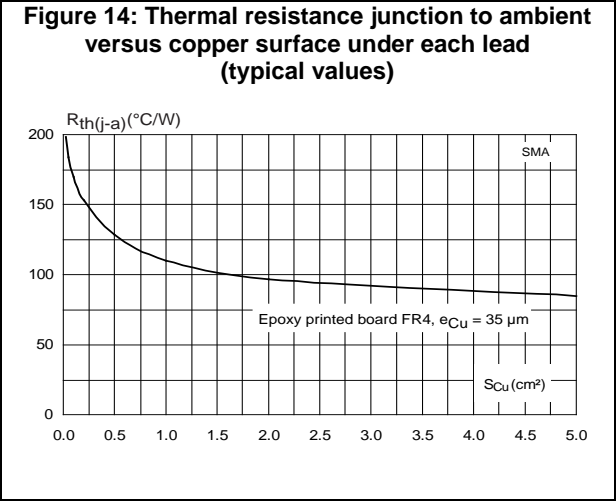
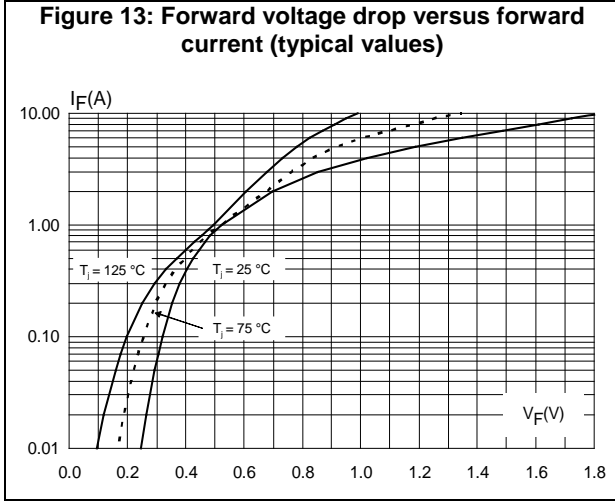
To evaluate the conduction losses, use the following equation:

$$P = 0.42 \times I_{F(AV)} + 0.12 \times I_{F(RMS)}^2$$

1.1 Characteristics (curves)







2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

- Epoxy meets UL94, V0
- Band indicates cathode

2.1 SMA package information

Figure 18: SMA package outline

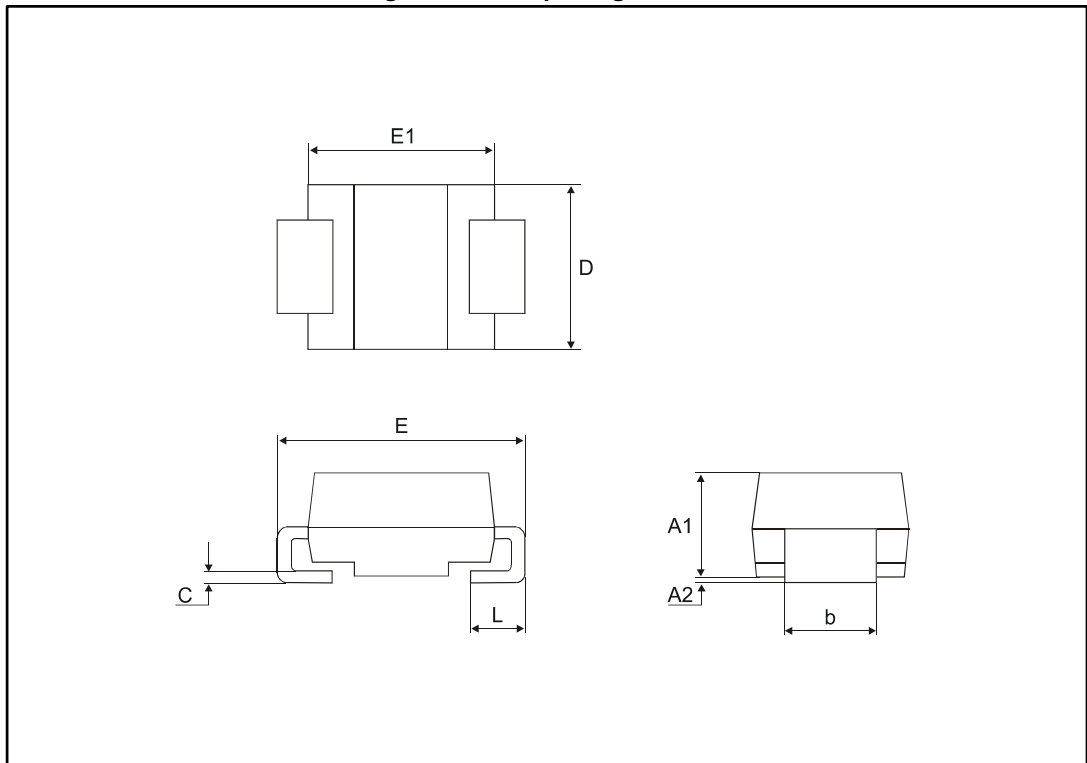
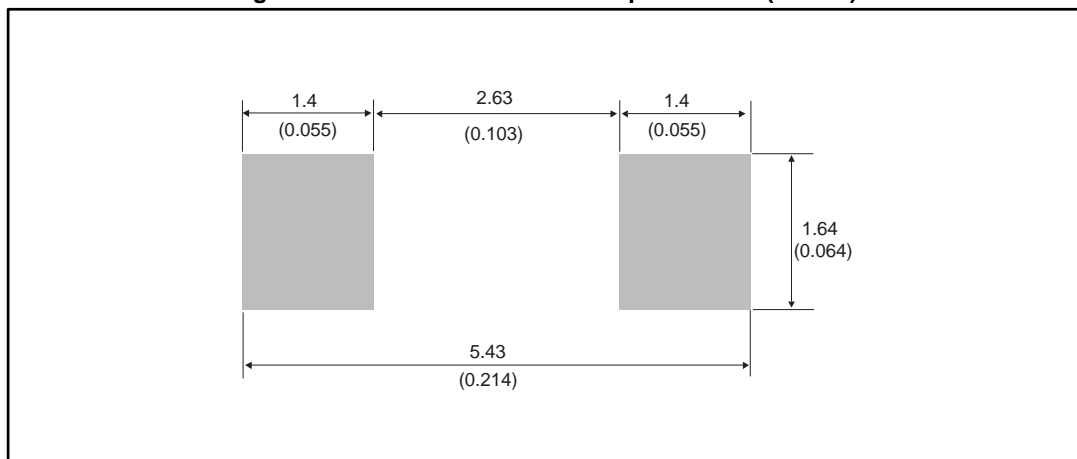


Table 5: SMA package mechanical data

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.097
A2	0.05	0.20	0.002	0.008
b	1.25	1.65	0.049	0.065
c	0.15	0.40	0.006	0.016
D	2.25	2.90	0.089	0.114
E	4.80	5.35	0.189	0.211
E1	3.95	4.60	0.156	0.181
L	0.75	1.50	0.030	0.059

Figure 19: SMA recommended footprint in mm (inches)



2.2 DO-41 package information

Figure 20: DO-41 package outline

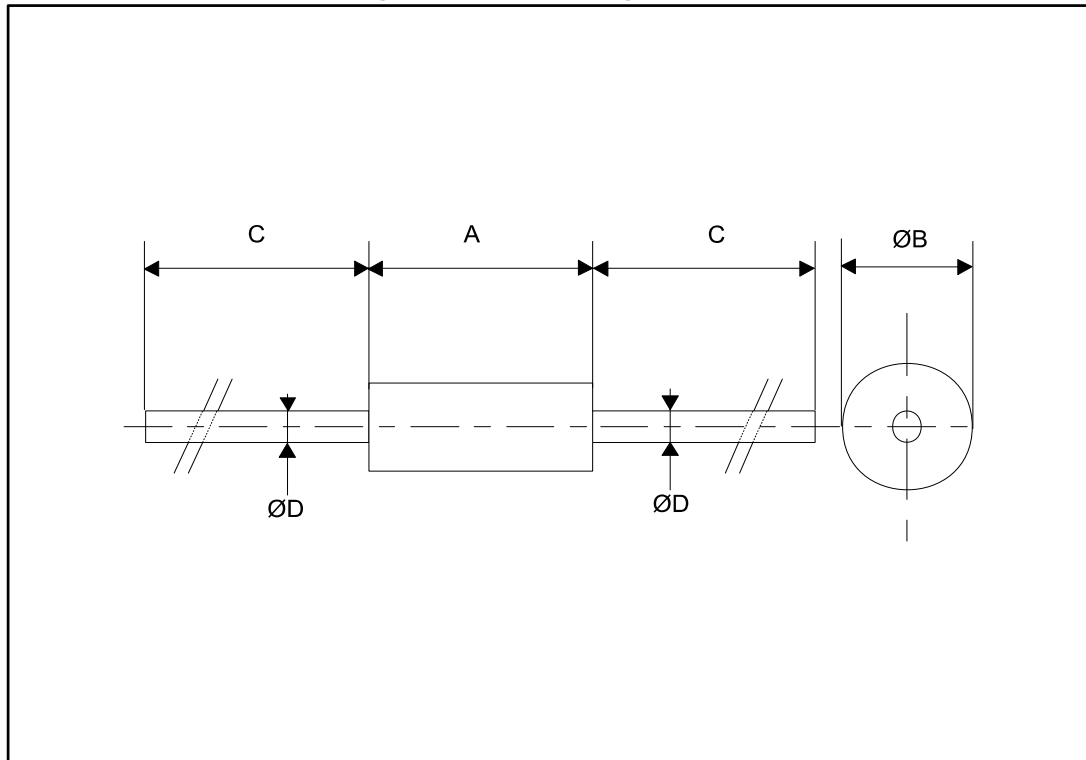


Table 6: DO-41 package mechanical data

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.07	5.20	0.160	0.205
ØB	2.04	2.71	0.080	0.107
C	25.40		1	
ØD	0.71	0.86	0.028	0.034

2.3 STmite flat package information

Figure 21: STmite flat package outline

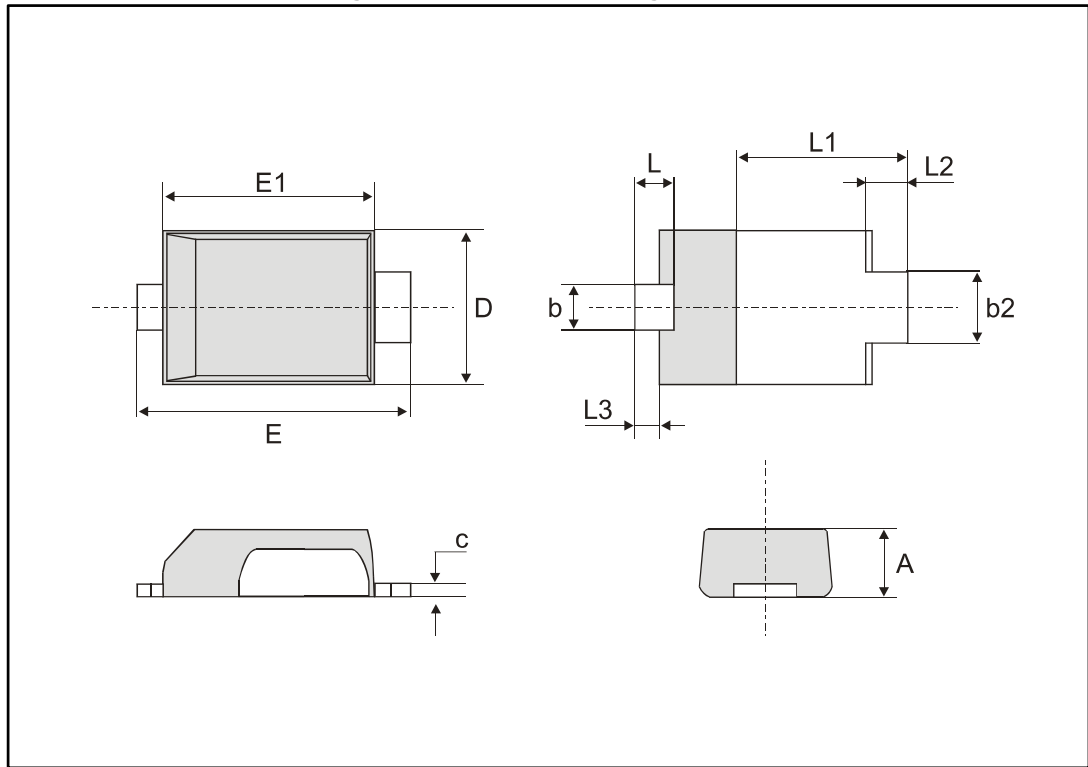
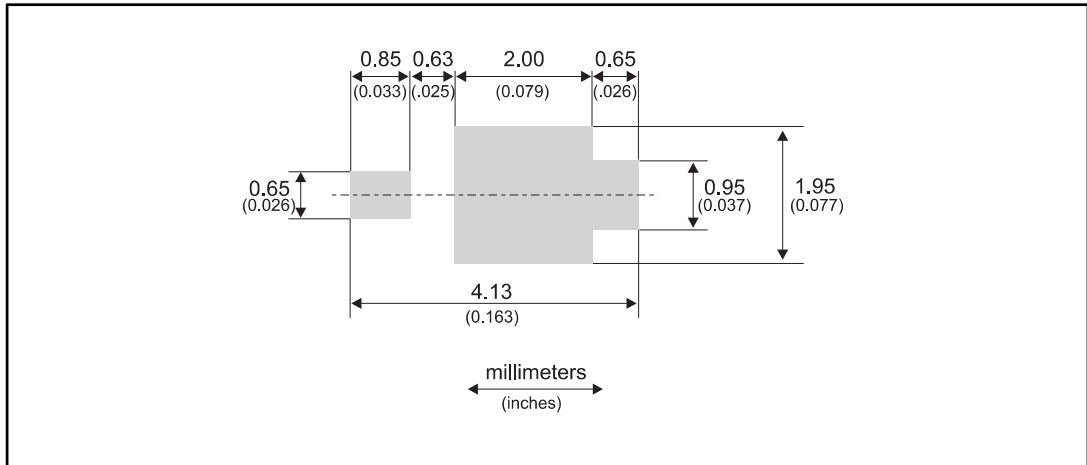


Table 7: STmite flat package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.80	0.85	0.95	0.031	0.033	0.037
b	0.40	0.55	0.65	0.016	0.022	0.026
b2	0.70	0.85	1.00	0.027	0.033	0.039
c	0.10	0.15	0.25	0.004	0.006	0.009
D	1.75	1.90	2.05	0.069	0.075	0.081
E	3.60	3.80	3.90	0.142	0.150	0.154
E1	2.80	2.95	3.10	0.110	0.116	0.122
L	0.50	0.55	0.80	0.020	0.022	0.031
L1	2.10	2.40	2.60	0.083	0.094	0.102
L2	0.45	0.60	0.75	0.018	0.021	0.030
L3	0.20	0.35	0.50	0.008	0.014	0.020

Figure 22: STmite flat recommended footprint in mm (inches)



2.4 SOD123Flat package information

Figure 23: SOD123Flat package outline

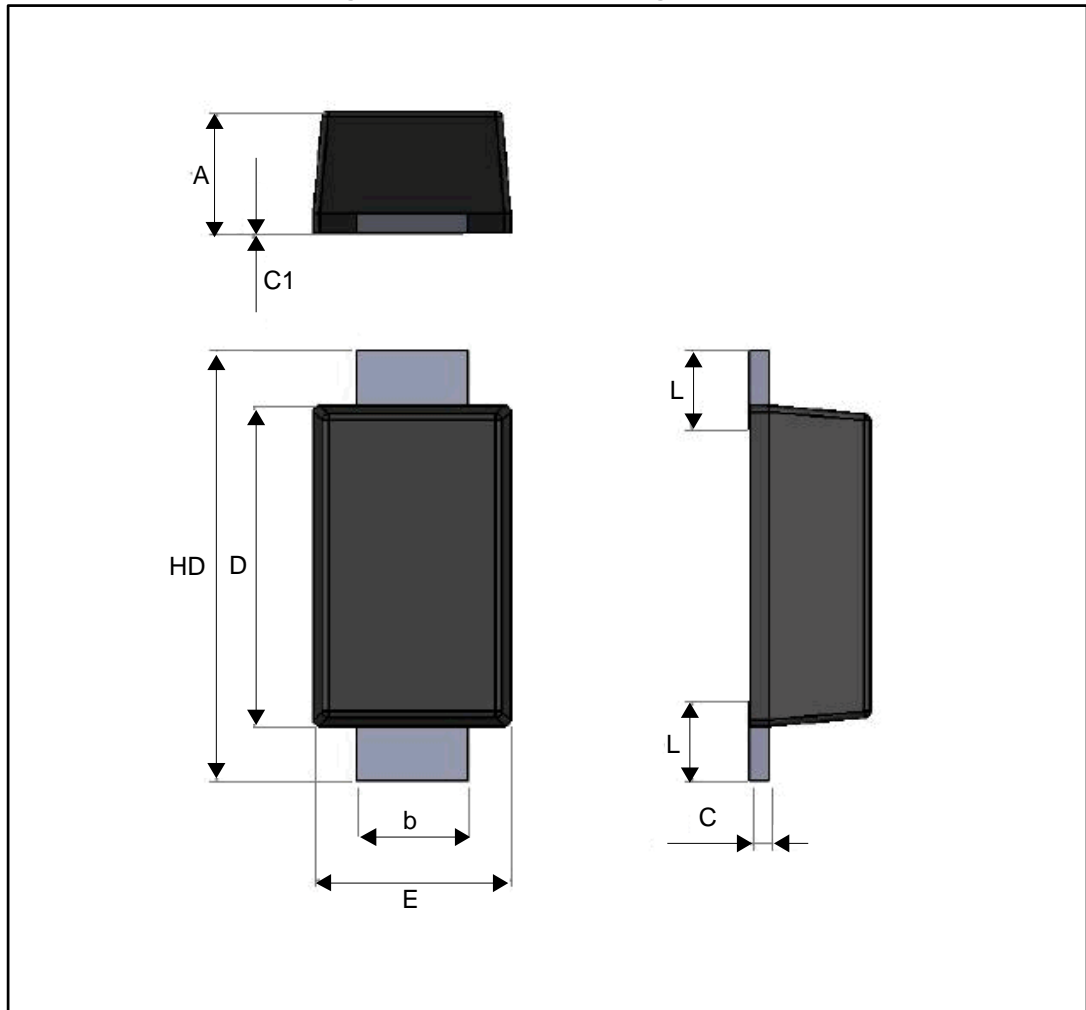
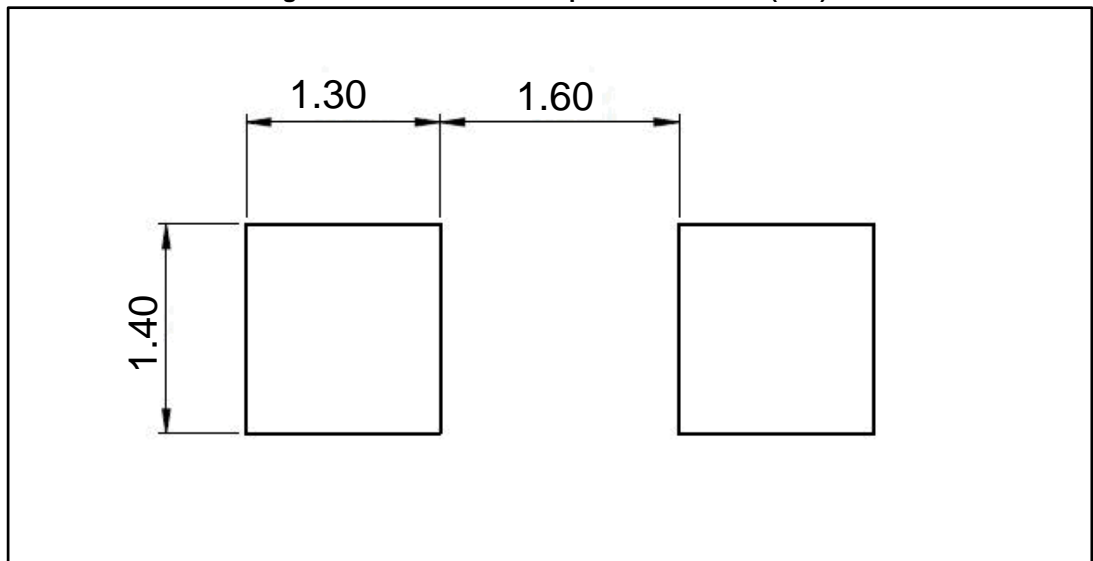


Table 8: SOD123Flat package mechanical data

Ref.	Dimensions		
	Millimeters		
	Min.	Typ.	Max.
A	0.86	0.98	1.10
b	0.80	0.90	1.00
c	0.08	0.15	0.25
c1	0.00		0.10
D	2.50	2.60	2.70
E	1.50	1.60	1.80
HD	3.30	3.50	3.70
L	0.45	0.65	0.85

Figure 24: SOD123Flat footprint dimensions (mm)



3 Ordering information

Table 9: Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS1L60A	GB6	SMA	68 mg	5000	Tape and reel
STPS1L60RL	STPS1L60	DO-41	340 mg	5000	Tape and reel
STPS1L60MF	F1L6	STmite flat	16 mg	12000	Tape and reel
STPS1L60ZF	1L6	SOD123Flat	12.5 mg	3000	Tape and reel

4 Revision history

Table 10: Document revision history

Date	Revision	Changes
Jul-2003	5A	Last update.
Aug-2004	6	SMA package dimensions update. Reference A1 max. changed from 2.70 mm (0.106 inch.) to 2.03 mm (0.080 inc.).
25-Jun-2009	7	Added STmite flat package. Updated ECOPACK statement
30-Sep-2009	8	Updated table 7 ref. "C"
19-Aug-2016	9	Added SOD123Flat package.
26-Aug-2016	10	Updated table 4 .

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